

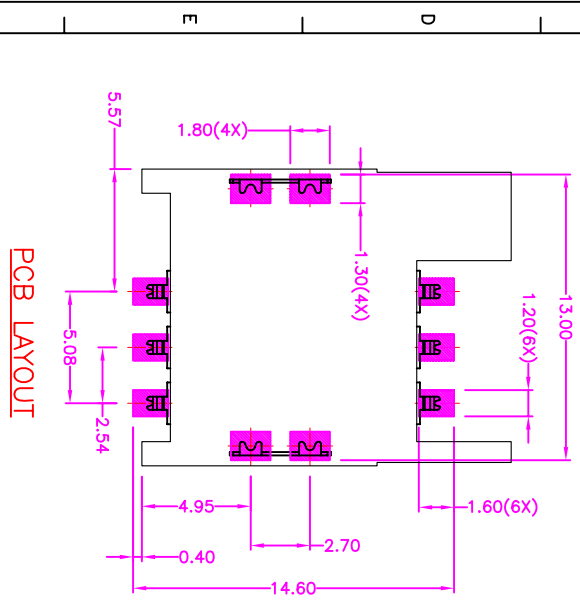
SECTION A-A

MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
 SHELL: SUS, NICKLE PLATED, AU 1U" MIN ON SOLDER TAIL.
 TERMINAL: COPPER ALLOY, GOLD PLATED ON CONTACT AREA GOLD PLATING ON SOLDER TAIL

SPECIFICATION

CURRENT RATING: 0.5 AMP MAX
 DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
 CONTACT RESISTANCE: 30m OHMS MAX
 INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
 OPERATION TEMPERATURE: -25°C~+85°C
 1200 PCS/REEL



PCB LAYOUT

PART NUMBER

CTP - 40GB - 0 6 1 T - 0 4 0

SERIES } PLATING ON SOLDER TAIL
 T : TTN
 NUMBER OF POS. } GOLD FLASH ON CONTACT

REV.	DATE	DESCRIPTION
A	0719,2012	RELEASE

TEL:+1 510 4400578 www.Connect-Tech-Products.com

Connect-Tech Products Corp.

TOLERANCES	UNIT	SCALE	SIZE	DRAW NO.	REV.
XX ±0.3	DRAWN BY	NONE	A4	D040-GB040	A
X.XX ±0.2					
X.XXX±0.1					
Angle ±5°	CHECKED BY	APPROVED BY			

MEMORY CARD SERIES
 MICRO SIM CARD HOLDER, 6 PIN, SMT,
 METAL SHIELD, FEMALE

9900N
 T.Q.W
 Jimmy